Renesas Electronics America Inc - R5F2122CJFP#U0 Datasheet

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	CANbus, I²C, LINbus, SIO, SSU, UART/USART
Peripherals	POR, Voltage Detect, WDT
Number of I/O	41
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	6K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f2122cjfp-u0

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1.2 Performance Overview

Table 1.1 outlines the Functions and Specifications for R8C/22 Group and Table 1.2 outlines the Functions and Specifications for R8C/23 Group.

Table 1.1 Functions and Specifications for R8C/22 Group

Item		Specification
CPU	Number of fundamental instructions	89 instructions
	Minimum instruction execution time	50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V) 100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)
	Operating mode	Single-chip
	Address space	1 Mbyte
	Memory capacity	Refer to **Table 1.3 Product Information for R8C/22 Group**
Peripheral Function	Ports	I/O ports: 41 pins, Input port: 3 pins
	Timers	Timer RA: 8 bits x 1 channel, Timer RB: 8 bits x 1 channel (Each timer equipped with 8-bit prescaler) Timer RD: 16 bits x 2 channel (Circuits of input capture and output compare) Timer RE: With compare match function
	Serial interface	1 channel (UART0) Clock synchronous I/O, UART 1 channel (UART1) UART
	Clock synchronous serial interface	1 channel I2C bus interface(2), Clock synchronous serial I/O with chip select
	LIN module	Hardware LIN: 1 channel (timer RA, UART0)
	CAN module	1 channel with 2.0B specification: 16 slots
	A/D converter	10-bit A/D converter: 1 circuit, 12 channels
	Watchdog timer	15 bits x 1 channel (with prescaler) Reset start selectable
	Interrupt	Internal: 14 sources, External: 6 sources, Software: 4 sources, Priority level: 7 levels
	Clock generation circuits	2 circuits XIN clock generation circuit (with on-chip feedback resistor) On-chip oscillator (high speed, low speed) High-speed on-chip oscillator has frequency adjustment function.
	Oscillation stop detection function	Stop detection of XIN clock oscillation
	Voltage detection circuit	On-chip
	Power-on reset circuit include	On-chip
Electric Characteristics	Supply voltage	VCC = 3.0 to 5.5 V (f(XIN) = 20 MHz)(D, J version) VCC = 3.0 to 5.5 V (f(XIN) = 16 MHz)(K version) VCC = 2.7 to 5.5 V (f(XIN) = 10 MHz)
	Current consumption	Typ. 12.5 mA (VCC = 5 V, f(XIN) = 20 MHz, High-speed on-chip oscillator stopping) Typ. 6.0 mA (VCC = 5 V, f(XIN) = 10 MHz, High-speed on-chip oscillator stopping)
Flash Memory	Programming and erasure voltage	VCC = 2.7 to 5.5 V
	Programming and erasure endurance	100 times
Operating Ambient Temperature		-40 to 85°C
		-40 to 125°C (option(1))
Package		48-pin mold-plastic LQFP

NOTES:
1. When using options, be sure to inquire about the specification.
2. I2C bus is a registered trademark of Koninklijke Philips Electronics N.V.

1.3 Block Diagram

Figure 1.1 shows a Block Diagram.

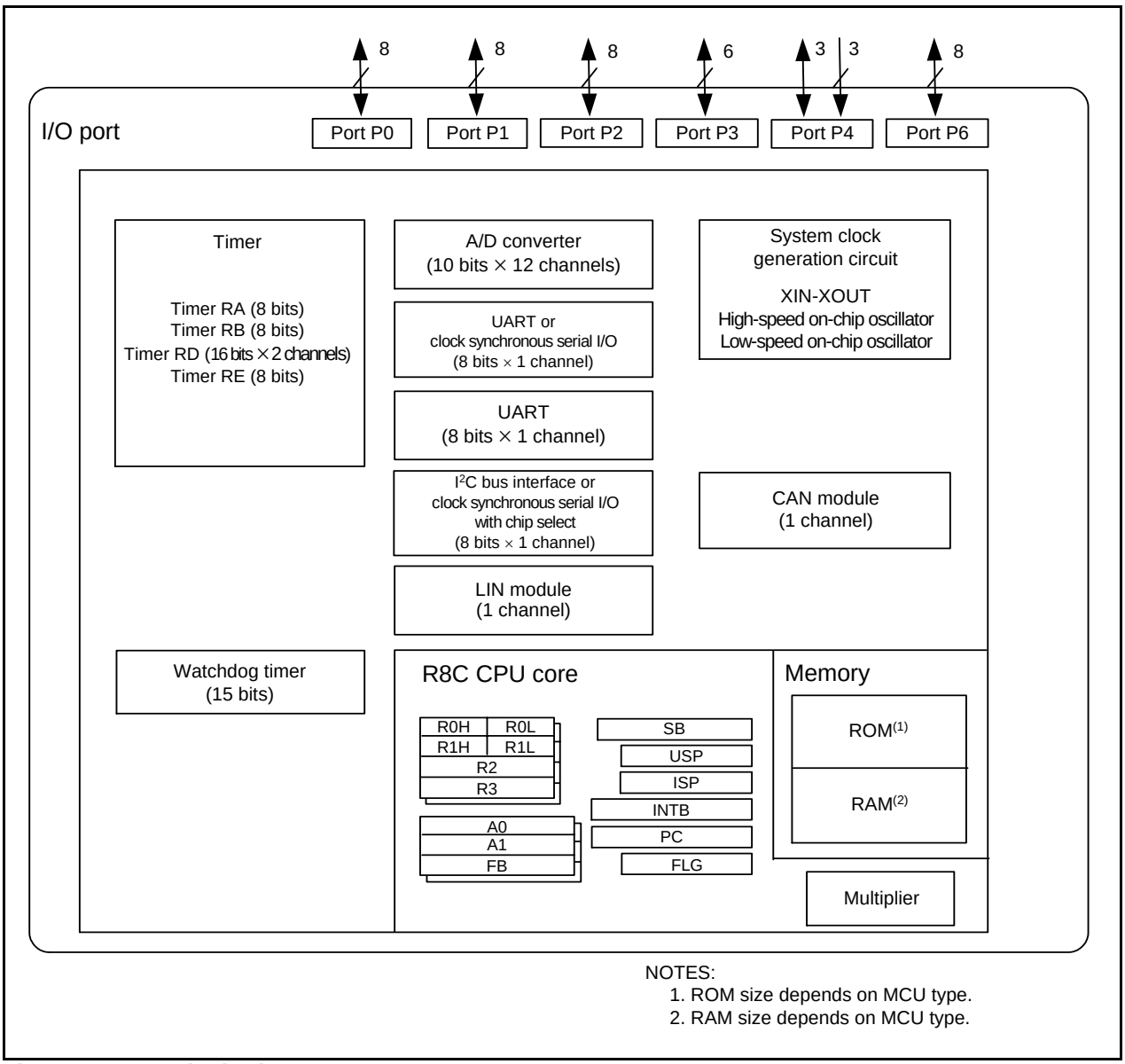

Figure 1.1 Block Diagram

1.4 Product Information

Table 1.3 lists Product Information for R8C/22 Group and Table 1.4 lists Product Information for R8C/23 Group.

Table 1.3 Product Information for R8C/22 Group **Current of Aug. 2008**

Type No.	ROM Capacity	RAM Capacity	Package Type	Remarks	
R5F21226DFP	32 Kbytes	2 Kbytes	PLQP0048KB-A	D version	Flash memory version
R5F21227DFP	48 Kbytes	2.5 Kbytes	PLQP0048KB-A		
R5F21228DFP	64 Kbytes	3 Kbytes	PLQP0048KB-A		
R5F21226JFP	32 Kbytes	2 Kbytes	PLQP0048KB-A	J version	
R5F21227JFP	48 Kbytes	2.5 Kbytes	PLQP0048KB-A		
R5F21228JFP	64 Kbytes	3 Kbytes	PLQP0048KB-A		
R5F2122AJFP	96 Kbytes	5 Kbytes	PLQP0048KB-A		
R5F2122CJFP	128 Kbytes(1)	6 Kbytes	PLQP0048KB-A		
R5F21226KFP	32 Kbytes	2 Kbytes	PLQP0048KB-A	K version	
R5F21227KFP	48 Kbytes	2.5 Kbytes	PLQP0048KB-A		
R5F21228KFP	64 Kbytes	3 Kbytes	PLQP0048KB-A		
R5F2122AKFP	96 Kbytes	5 Kbytes	PLQP0048KB-A		
R5F2122CKFP	128 Kbytes(1)	6 Kbytes	PLQP0048KB-A		

NOTE:
1. Do not use addresses 20000h to 23FFFh because these areas are used for the emulator debugger. Refer to **24. Notes on Emulator Debugger** of Hardware Manual.

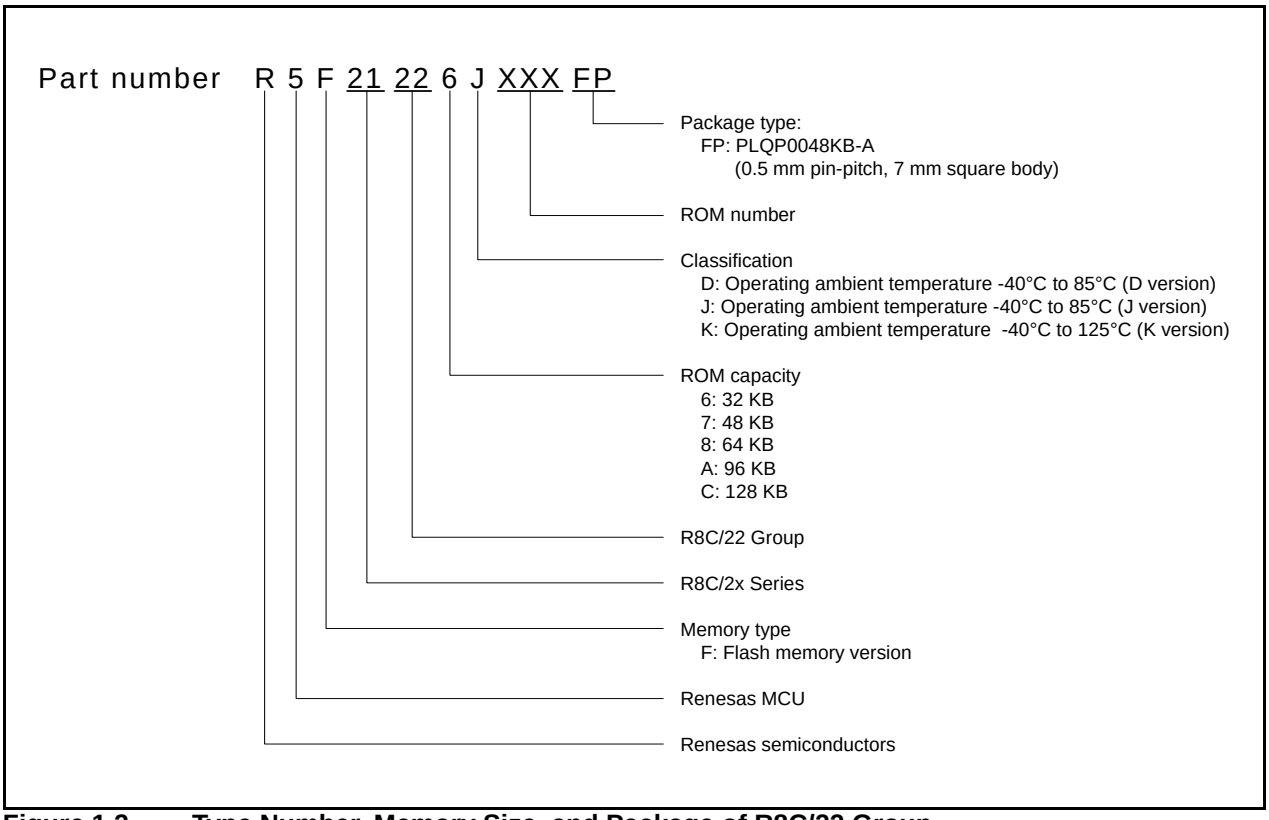

Figure 1.2 Type Number, Memory Size, and Package of R8C/22 Group

Table 1.4 Product Information for R8C/23 Group **Current of Aug. 2008**

Type No.	ROM Capacity		RAM Capacity	Package Type	Remarks	
	Program ROM	Data Flash				
R5F21236DFP	32 Kbytes	1 Kbyte X 2	2 Kbytes	PLQP0048KB-A	D version	Flash memory version
R5F21237DFP	48 Kbytes	1 Kbyte X 2	2.5 Kbytes	PLQP0048KB-A		
R5F21238DFP	64 Kbytes	1 Kbyte X 2	3 Kbytes	PLQP0048KB-A		
R5F21236JFP	32 Kbytes	1 Kbyte X 2	2 Kbytes	PLQP0048KB-A	J version	
R5F21237JFP	48 Kbytes	1 Kbyte X 2	2.5 Kbytes	PLQP0048KB-A		
R5F21238JFP	64 Kbytes	1 Kbyte X 2	3 Kbytes	PLQP0048KB-A		
R5F2123AJFP	96 Kbytes	1 Kbyte X 2	5 Kbytes	PLQP0048KB-A		
R5F2123CJFP	128 Kbytes(1)	1 Kbyte X 2	6 Kbytes	PLQP0048KB-A		
R5F21236KFP	32 Kbytes	1 Kbyte X 2	2 Kbytes	PLQP0048KB-A	K version	
R5F21237KFP	48 Kbytes	1 Kbyte X 2	2.5 Kbytes	PLQP0048KB-A		
R5F21238KFP	64 Kbytes	1 Kbyte X 2	3 Kbytes	PLQP0048KB-A		
R5F2123AKFP	96 Kbytes	1 Kbyte X 2	5 Kbytes	PLQP0048KB-A		
R5F2123CKFP	128 Kbytes(1)	1 Kbyte X 2	6 Kbytes	PLQP0048KB-A		

NOTE:
1. Do not use addresses 20000h to 23FFFh because these areas are used for the emulator debugger. Refer to **24. Notes on Emulator Debugger** of Hardware Manual.

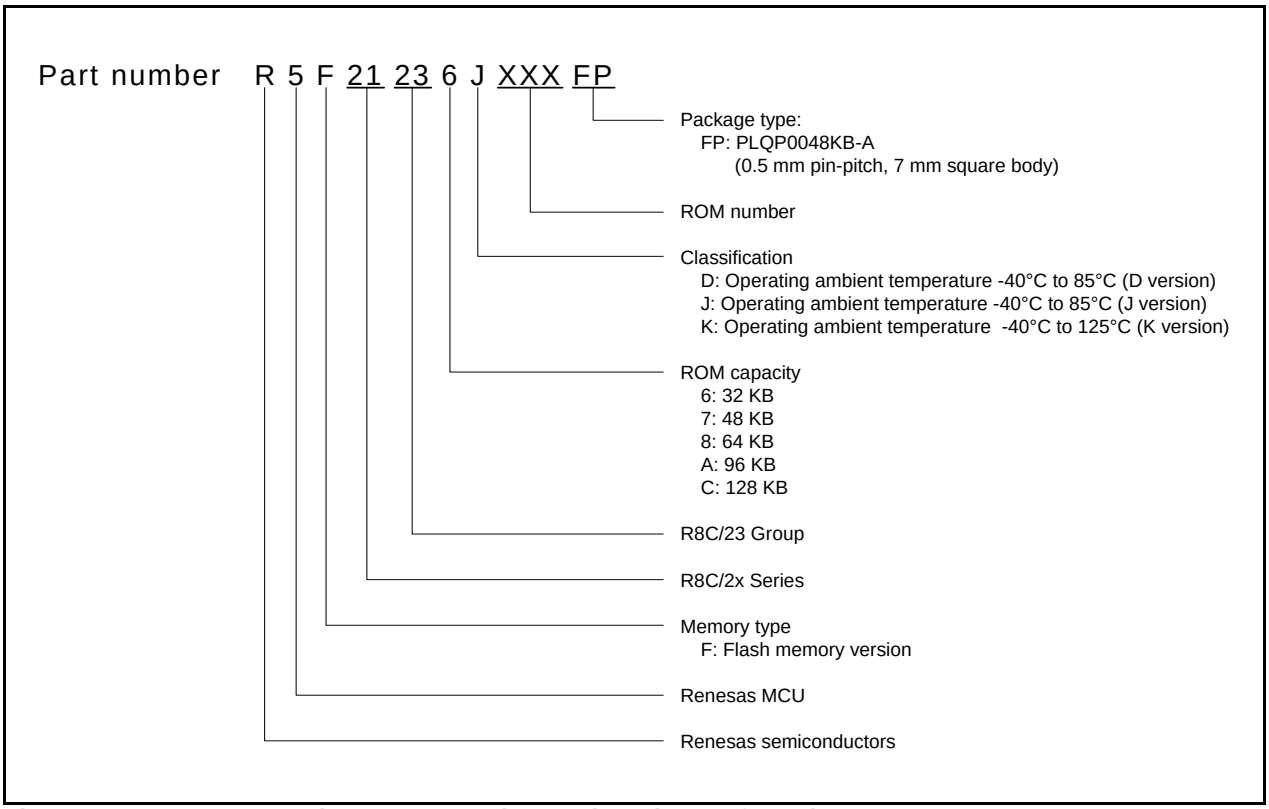

Figure 1.3 Type Number, Memory Size, and Package of R8C/23 Group

Table 1.6 Pin Name Information by Pin Number

Pin Number	Control Pin	Port	I/O Pin Functions for of Peripheral Modules						
			Interrupt	Timer	Serial Interface	Clock Synchronous Serial I/O with Chip Select	I^2C Bus Interface	CAN Module	A/D Converter
1		P3_5				SSCK	SCL		
2		P3_3				SSI			
3		P3_4				$\overline{SCS}$	SDA		
4	MODE								
5		P4_3							
6		P4_4							
7	$\overline{RESET}$								
8	XOUT	P4_7							
9	VSS/AVSS								
10	XIN	P4_6							
11	VCC/AVCC								
12		P2_7		TRDIOD1					
13		P2_6		TRDIOC1					
14		P2_5		TRDIOB1					
15		P2_4		TRDIOA1					
16		P2_3		TRDIOD0					
17		P2_2		TRDIOC0					
18		P2_1		TRDIOB0					
19		P2_0		TRDIOA0/TRDCLK					
20		P1_7	$\overline{INT1}$	TRAIO					
21		P1_6			CLK0				
22		P1_5	($\overline{INT1}$)(1)	(TRAIO)(1)	RXD0				
23		P1_4			TXD0				
24		P1_3	$\overline{KI3}$						AN11
25		P4_5	$\overline{INT0}$	$\overline{INT0}$					
26		P6_6	$\overline{INT2}$		TXD1				
27		P6_7	$\overline{INT3}$		RXD1				
28		P1_2	$\overline{KI2}$						AN10
29		P1_1	$\overline{KI1}$						AN9
30		P1_0	$\overline{KI0}$						AN8
31		P3_1		TRBO					
32		P3_0		TRAO					
33		P6_5							
34		P6_4							
35		P6_3							
36		P0_7							AN0
37		P0_6							AN1
38		P0_5							AN2
39		P0_4							AN3
40	VREF	P4_2							
41		P6_0		TREO					
42		P6_2						CRX0	
43		P6_1						CTX0	
44		P0_3							AN4
45		P0_2							AN5
46		P0_1							AN6
47		P0_0							AN7
48		P3_7				SSO			

NOTE:
1. Can be assigned to the pin in parentheses by a program.

2.1 Data Registers (R0, R1, R2 and R3)

R0 is a 16-bit register for transfer, arithmetic, and logic operations. The same applies to R1 to R3.
R0 can be split into high-order bit (R0H) and low-order bit (R0L) to be used separately as 8-bit data registers. The same applies to R1H and R1L as R0H and R0L. R2 can be combined with R0 to be used as a 32-bit data register (R2R0). The same applies R3R1 as R2R0.

2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. They also are used for transfer, arithmetic and logic operations. The same applies to A1 as A0.
A1 can be combined with A0 to be used a 32-bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB, a 20-bit register, indicates the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC, 20 bits wide, indicates the address of an instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointer (SP), USP and ISP, are 16 bits wide each.
The U flag of FLG is used to switch between USP and ISP.

2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

2.8 Flag Register (FLG)

FLG is a 11-bit register indicating the CPU status.

2.8.1 Carry Flag (C)

The C flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic and logic unit.

2.8.2 Debug Flag (D)

The D flag is for debug only. Set to 0.

2.8.3 Zero Flag (Z)

The Z flag is set to 1 when an arithmetic operation resulted in 0; otherwise, 0.

2.8.4 Sign Flag (S)

The S flag is set to 1 when an arithmetic operation resulted in a negative value; otherwise, 0.

2.8.5 Register Bank Select Flag (B)

The register bank 0 is selected when the B flag is 0. The register bank 1 is selected when this flag is set to 1.

2.8.6 Overflow Flag (O)

The O flag is set to 1 when the operation resulted in an overflow; otherwise, 0.

Table 4.3 SFR Information (3)(1)

Address	Register	Symbol	After reset
0080h			
0081h			
0082h			
0083h			
0084h			
0085h			
0086h			
0087h			
0088h			
0089h			
008Ah			
008Bh			
008Ch			
008Dh			
008Eh			
008Fh			
0090h			
0091h			
0092h			
0093h			
0094h			
0095h			
0096h			
0097h			
0098h			
0099h			
009Ah			
009Bh			
009Ch			
009Dh			
009Eh			
009Fh			
00A0h	UART0 Transmit/Receive Mode Register	U0MR	00h
00A1h	UART0 Bit Rate Register	U0BRG	XXh
00A2h	UART0 Transmit Buffer Register	U0TB	XXh
00A3h			XXh
00A4h	UART0 Transmit/Receive Control Register 0	U0C0	00001000b
00A5h	UART0 Transmit/Receive Control Register 1	U0C1	00000010b
00A6h	UART0 Receive Buffer Register	U0RB	XXh
00A7h			XXh
00A8h	UART1 Transmit/Receive Mode Register	U1MR	00h
00A9h	UART1 Bit Rate Register	U1BRG	XXh
00AAh	UART1 Transmit Buffer Register	U1TB	XXh
00ABh			XXh
00ACh	UART1 Transmit/Receive Control Register 0	U1C0	00001000b
00ADh	UART1 Transmit/Receive Control Register 1	U1C1	00000010b
00AEh	UART1 Receive Buffer Register	U1RB	XXh
00AFh			XXh
00B0h			
00B1h			
00B2h			
00B3h			
00B4h			
00B5h			
00B6h			
00B7h			
00B8h	SS Control Register H/IIC Bus Control Register 1(2)	SSCRH/ICCR1	00h
00B9h	SS Control Register L/IIC Bus Control Register 2(2)	SSCRL/ICCR2	01111101b
00BAh	SS Mode Register/IIC Bus Mode Register 1(2)	SSMR/ICMR	00011000b
00BBh	SS Enable Register/IIC Bus Interrupt Enable Register(2)	SSER/ICIER	00h
00BCh	SS Status Register/IIC Bus Status Register(2)	SSSR/ICSR	00h/0000X000b
00BDh	SS Mode Register 2/Slave Address Register(2)	SSMR2/SAR	00h
00BEh	SS Transmit Data Register/IIC Bus Transmit Data Register(2)	SSTDR/ICDRT	FFh
00BFh	SS Receive Data Register/IIC Bus Receive Data Register(2)	SSRDR/ICDRR	FFh

X: Undefined

NOTES:

1. The blank regions are reserved. Do not access locations in these regions.
2. Selected by the IICSEL bit in the PMR register.

Table 4.7 SFR Information (7)(1)

Address	Register	Symbol	After reset
0180h			
0181h			
0182h			
0183h			
0184h			
0185h			
0186h			
0187h			
0188h			
0189h			
018Ah			
018Bh			
018Ch			
018Dh			
018Eh			
018Fh			
0190h			
0191h			
0192h			
0193h			
0194h			
0195h			
0196h			
0197h			
0198h			
0199h			
019Ah			
019Bh			
019Ch			
019Dh			
019Eh			
019Fh			
01A0h			
01A1h			
01A2h			
01A3h			
01A4h			
01A5h			
01A6h			
01A7h			
01A8h			
01A9h			
01AAh			
01ABh			
01ACh			
01ADh			
01AEh			
01AFh			
01B0h			
01B1h			
01B2h			
01B3h	Flash Memory Control Register 4	FMR4	01000000b
01B4h			
01B5h	Flash Memory Control Register 1	FMR1	1000000Xb
01B6h			
01B7h	Flash Memory Control Register 0	FMR0	00000001b
01B8h			
01B9h			
01BAh			
01BBh			
01FDh			
01FEh			
01FFh			

X: Undefined

NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

Table 4.8 SFR Information (8)(1)

Address	Register	Symbol	After reset
1300h	CAN0 Message Control Register 0	C0MCTL0	00h
1301h	CAN0 Message Control Register 1	C0MCTL1	00h
1302h	CAN0 Message Control Register 2	C0MCTL2	00h
1303h	CAN0 Message Control Register 3	C0MCTL3	00h
1304h	CAN0 Message Control Register 4	C0MCTL4	00h
1305h	CAN0 Message Control Register 5	C0MCTL5	00h
1306h	CAN0 Message Control Register 6	C0MCTL6	00h
1307h	CAN0 Message Control Register 7	C0MCTL7	00h
1308h	CAN0 Message Control Register 8	C0MCTL8	00h
1309h	CAN0 Message Control Register 9	C0MCTL9	00h
130Ah	CAN0 Message Control Register 10	C0MCTL10	00h
130Bh	CAN0 Message Control Register 11	C0MCTL11	00h
130Ch	CAN0 Message Control Register 12	C0MCTL12	00h
130Dh	CAN0 Message Control Register 13	C0MCTL13	00h
130Eh	CAN0 Message Control Register 14	C0MCTL14	00h
130Fh	CAN0 Message Control Register 15	C0MCTL15	00h
1310h	CAN0 Control Register	C0CTLR	X0000001b
1311h			XX0X0000b
1312h	CAN0 Status Register	C0STR	00h
1313h			X0000001b
1314h	CAN0 Slot Status Register	C0SSTR	00h
1315h			00h
1316h	CAN0 Interrupt Control Register	C0ICR	00h
1317h			00h
1318h	CAN0 Extended ID Register	C0IDR	00h
1319h			00h
131Ah	CAN0 Configuration Register	C0CONR	XXh
131Bh			XXh
131Ch	CAN0 Receive Error Count Register	C0RECR	00h
131Dh	CAN0 Transmit Error Count Register	C0TECR	00h
131Eh			
131Fh			
1320h			
1321h			
1322h			
1323h			
1324h			
1325h			
1326h			
1327h			
1328h			
1329h			
132Ah			
132Bh			
132Ch			
132Dh			
132Eh			
132Fh			
1330h			
1331h			
1332h			
1333h			
1334h			
1335h			
1336h			
1337h			
1338h			
1339h			
133Ah			
133Bh			
133Ch			
133Dh			
133Eh			
133Fh			

X: Undefined

NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

Table 4.9 SFR Information (9)(1)

Address	Register	Symbol	After reset
1340h			
1341h			
1342h	CAN0 Acceptance Filter Support Register	C0AFS	XXh
1343h			XXh
1344h			
1345h			
1346h			
1347h			
1348h			
1349h			
134Ah			
134Bh			
134Ch			
134Dh			
134Eh			
134Fh			
1350h			
1351h			
1352h			
1353h			
1354h			
1355h			
1356h			
1357h			
1358h			
1359h			
135Ah			
135Bh			
135Ch			
135Dh			
135Eh			
135Fh	CAN0 Clock Select Register	CCLKR	00h
1360h	CAN0 Slot 0: Identifier/DLC		XXh
1361h			XXh
1362h			XXh
1363h			XXh
1364h			XXh
1365h			XXh
1366h	CAN0 Slot 0: Data Field		XXh
1367h			XXh
1368h			XXh
1369h			XXh
136Ah			XXh
136Bh			XXh
136Ch			XXh
136Dh			XXh
136Eh	CAN0 Slot 0: Time Stamp		XXh
136Fh			XXh
1370h	CAN0 Slot 1: Identifier/DLC		XXh
1371h			XXh
1372h			XXh
1373h			XXh
1374h			XXh
1375h			XXh
1376h	CAN0 Slot 1: Data Field		XXh
1377h			XXh
1378h			XXh
1379h			XXh
137Ah			XXh
137Bh			XXh
137Ch			XXh
137Dh			XXh
137Eh	CAN0 Slot 1: Time Stamp		XXh
137Fh			XXh

X: Undefined

NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

Table 4.11 SFR Information (11)(1)

Address	Register	Symbol	After reset
13C0h	CAN0 Slot 6: Identifier/DLC		XXh
13C1h			XXh
13C2h			XXh
13C3h			XXh
13C4h			XXh
13C5h			XXh
13C6h	CAN0 Slot 6: Data Field		XXh
13C7h			XXh
13C8h			XXh
13C9h			XXh
13CAh			XXh
13CBh			XXh
13CCh			XXh
13CDh			XXh
13CEh	CAN0 Slot 6: Time Stamp		XXh
13CFh			XXh
13D0h	CAN0 Slot 7: Identifier/DLC		XXh
13D1h			XXh
13D2h			XXh
13D3h			XXh
13D4h			XXh
13D5h			XXh
13D6h	CAN0 Slot 7: Data Field		XXh
13D7h			XXh
13D8h			XXh
13D9h			XXh
13DAh			XXh
13DBh			XXh
13DCh			XXh
13DDh			XXh
13DEh	CAN0 Slot 7: Time Stamp		XXh
13DFh			XXh
13E0h	CAN0 Slot 8: Identifier/DLC		XXh
13E1h			XXh
13E2h			XXh
13E3h			XXh
13E4h			XXh
13E5h			XXh
13E6h	CAN0 Slot 8: Data Field		XXh
13E7h			XXh
13E8h			XXh
13E9h			XXh
13EAh			XXh
13EBh			XXh
13ECh			XXh
13EDh			XXh
13EEh	CAN0 Slot 8: Time Stamp		XXh
13EFh			XXh
13F0h	CAN0 Slot 9: Identifier/DLC		XXh
13F1h			XXh
13F2h			XXh
13F3h			XXh
13F4h			XXh
13F5h			XXh
13F6h	CAN0 Slot 9: Data Field		XXh
13F7h			XXh
13F8h			XXh
13F9h			XXh
13FAh			XXh
13FBh			XXh
13FCh			XXh
13FDh			XXh
13FEh	CAN0 Slot 9: Time Stamp		XXh
13FFh			XXh

X: Undefined

NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

Table 4.12 SFR Information (12)(1)

Address	Register	Symbol	After reset
1400h	CAN0 Slot 10: Identifier/DLC		XXh
1401h			XXh
1402h			XXh
1403h			XXh
1404h			XXh
1405h			XXh
1406h	CAN0 Slot 10: Data Field		XXh
1407h			XXh
1408h			XXh
1409h			XXh
140Ah			XXh
140Bh			XXh
140Ch			XXh
140Dh			XXh
140Eh	CAN0 Slot 10: Time Stamp		XXh
140Fh			XXh
1410h	CAN0 Slot 11: Identifier/DLC		XXh
1411h			XXh
1412h			XXh
1413h			XXh
1414h			XXh
1415h			XXh
1416h	CAN0 Slot 11: Data Field		XXh
1417h			XXh
1418h			XXh
1419h			XXh
141Ah			XXh
141Bh			XXh
141Ch			XXh
141Dh			XXh
141Eh	CAN0 Slot 11: Time Stamp		XXh
141Fh			XXh
1420h	CAN0 Slot 12: Identifier/DLC		XXh
1421h			XXh
1422h			XXh
1423h			XXh
1424h			XXh
1425h			XXh
1426h	CAN0 Slot 12: Data Field		XXh
1427h			XXh
1428h			XXh
1429h			XXh
142Ah			XXh
142Bh			XXh
142Ch			XXh
142Dh			XXh
142Eh	CAN0 Slot 12: Time Stamp		XXh
142Fh			XXh
1430h	CAN0 Slot 13: Identifier/DLC		XXh
1431h			XXh
1432h			XXh
1433h			XXh
1434h			XXh
1435h			XXh
1436h	CAN0 Slot 13: Data Field		XXh
1437h			XXh
1438h			XXh
1439h			XXh
143Ah			XXh
143Bh			XXh
143Ch			XXh
143Dh			XXh
143Eh	CAN0 Slot 13: Time Stamp		XXh
143Fh			XXh

X: Undefined

NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

Table 4.13 SFR Information (13)(1)

Address	Register	Symbol	After reset
1440h	CAN0 Slot 14: Identifier/DLC		XXh
1441h			XXh
1442h			XXh
1443h			XXh
1444h			XXh
1445h			XXh
1446h	CAN0 Slot 14: Data Field		XXh
1447h			XXh
1448h			XXh
1449h			XXh
144Ah			XXh
144Bh			XXh
144Ch			XXh
144Dh			XXh
144Eh	CAN0 Slot 14: Time Stamp		XXh
144Fh			XXh
1450h	CAN0 Slot 15: Identifier/DLC		XXh
1451h			XXh
1452h			XXh
1453h			XXh
1454h			XXh
1455h			XXh
1456h	CAN0 Slot 15: Data Field		XXh
1457h			XXh
1458h			XXh
1459h			XXh
145Ah			XXh
145Bh			XXh
145Ch			XXh
145Dh			XXh
145Eh	CAN0 Slot 15: Time Stamp		XXh
145Fh			XXh
1460h	CAN0 Global Mask Register	C0GMR	XXh
1461h			XXh
1462h			XXh
1463h			XXh
1464h			XXh
1465h			XXh
1466h	CAN0 Local Mask A Register	C0LMAR	XXh
1467h			XXh
1468h			XXh
1469h			XXh
146Ah			XXh
146Bh			XXh
146Ch	CAN0 Local Mask B Register	C0LMBR	XXh
146Dh			XXh
146Eh			XXh
146Fh			XXh
1470h			XXh
1471h			XXh
1472h			
1473h			
1474h			
1475h			

FFFFh	Option Function Select Register	OFS	(Note 2)

X: Undefined

NOTES:

1. The blank regions are reserved. Do not access locations in these regions.
2. The OFS register cannot be changed by a program. Use a flash programmer to write to it.

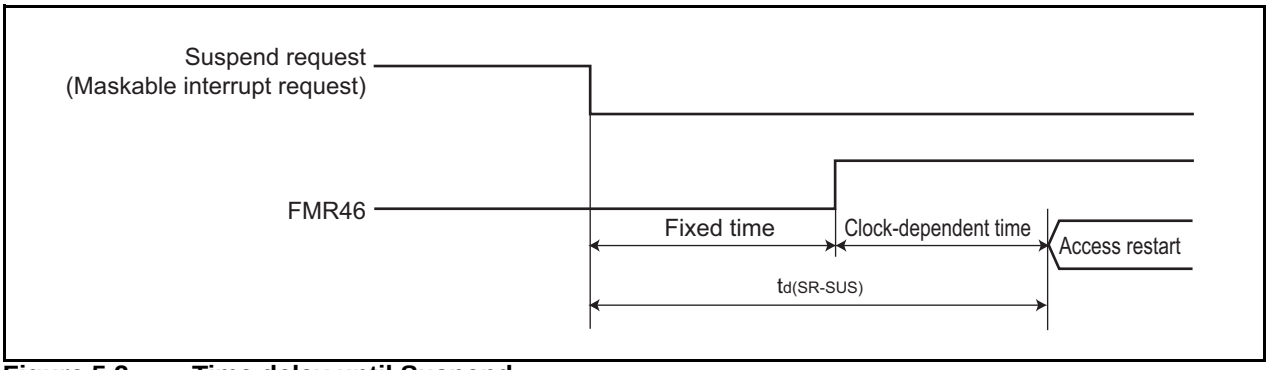

Figure 5.2 Time delay until Suspend

Table 5.6 Voltage Detection 1 Circuit Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
V_{det1}	Voltage detection level(3, 4)		2.70	2.85	3.00	V
$t_{d(Vdet1-A)}$	Voltage monitor 1 reset generation time(5)		–	40	200	µs
–	Voltage detection circuit self power consumption	VCA26 = 1, V_{CC} = 5.0 V	–	0.6	–	µA
$t_{d(E-A)}$	Waiting time until voltage detection circuit operation starts(2)		–	–	100	µs
Vccmin	MCU operating voltage minimum value		2.70	–	–	V

NOTES:
1. The measurement condition is V_{CC} = 2.7 V to 5.5 V and Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version).
2. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.
3. Hold $V_{det2} > V_{det1}$.
4. This parameter shows the voltage detection level when the power supply drops. The voltage detection level when the power supply rises is higher than the voltage detection level when the power supply drops by approximately 0.1 V.
5. Time until the voltage monitor 1 reset is generated after the voltage passes V_{det1} when V_{CC} falls. When using the digital filter, its sampling time is added to $t_{d(Vdet1-A)}$. When using the voltage monitor 1 reset, maintain this time until V_{CC} = 2.0 V after the voltage passes V_{det1} when the power supply falls.

Table 5.7 Voltage Detection 2 Circuit Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
V_{det2}	Voltage detection level(4)		3.3	3.6	3.9	V
$t_{d(Vdet2-A)}$	Voltage monitor 2 reset/interrupt request generation time(2, 5)		–	40	200	µs
–	Voltage detection circuit self power consumption	VCA27 = 1, V_{CC} = 5.0V	–	0.6	–	µA
$t_{d(E-A)}$	Waiting time until voltage detection circuit operation starts(3)		–	–	100	µs

NOTES:
1. The measurement condition is V_{CC} = 2.7 V to 5.5 V and Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version).
2. Time until the voltage monitor 2 reset/interrupt request is generated since the voltage passes V_{det2}.
3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.
4. Hold $V_{det2} > V_{det1}$.
5. When using the digital filter, its sampling time is added to $t_{d(Vdet2-A)}$. When using the voltage monitor 2 reset, maintain this time until V_{CC} = 2.0 V after the voltage passes V_{det2} when the power supply falls.

Table 5.9 High-Speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
fOCO40M	High-speed on-chip oscillator frequency temperature • supply voltage dependence	V_{CC} = 4.75 V to 5.25 V, 0°C ≤ Topr ≤ 60°C(2)	39.2	40	40.8	MHz
		V_{CC} = 3.0 V to 5.25 V, -20°C ≤ Topr ≤ 85°C(2)	38.8	40	41.2	MHz
		V_{CC} = 3.0 V to 5.5 V, -40°C ≤ Topr ≤ 85°C(2)	38.4	40	41.6	MHz
		V_{CC} = 3.0 V to 5.5 V, -40°C ≤ Topr ≤ 125°C(2)	38.0	40	42.0	MHz
		V_{CC} = 2.7 V to 5.5 V, -40°C ≤ Topr ≤ 125°C(2)	37.6	40	42.4	MHz
–	The value of the FRA1 register when the reset is deasserted		08h	40	F7h	–
–	High-speed on-chip oscillator adjustment range	Adjust the FRA1 register to -1 bit (the value when the reset is deasserted)	–	+ 0.3	–	MHz
–	Oscillation stability time		–	10	100	µs
–	Self power consumption when high-speed on-chip oscillator oscillating	V_{CC} = 5.0 V, Topr = 25°C	–	600	–	µA

NOTES:
1. V_{CC} = 2.7 V to 5.5 V, Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version), unless otherwise specified.
2. The standard value shows when the reset is deasserted for the FRA1 register.

Table 5.10 Low-Speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
fOCO-S	Low-speed on-chip oscillator frequency		40	125	250	kHz
–	Oscillation stability time		–	10	100	µs
–	Self power consumption when low-speed on-chip oscillator oscillating	V_{CC} = 5.0 V, Topr = 25°C	–	15	–	µA

NOTE:
1. V_{CC} = 2.7 V to 5.5 V, Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version), unless otherwise specified.

Table 5.11 Power Supply Circuit Timing Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
$t_{d(P-R)}$	Time for internal power supply stabilization during power-on(2)		1	–	2000	µs
$t_{d(R-S)}$	STOP exit time(3)		–	–	150	µs

NOTES:
1. The measurement condition is V_{CC} = 2.7 to 5.5 V and Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.
2. Waiting time until the internal power supply generation circuit stabilizes during power-on.
3. Time until CPU clock supply starts since the interrupt is acknowledged to exit stop mode.

Table 5.14 Electrical Characteristics (1) [Vcc = 5 V]

Symbol	Parameter		Condition		Standard			Unit
					Min.	Typ.	Max.	
V_{OH}	Output “H” Voltage	Except XOUT	I_{OH} = -5 mA		Vcc – 2.0	–	Vcc	V
			I_{OH} = -200 μA		Vcc – 0.3	–	Vcc	V
		XOUT	Drive capacity HIGH	I_{OH} = -1 mA	Vcc – 2.0	–	Vcc	V
			Drive capacity LOW	I_{OH} = -500 μA	Vcc – 2.0	–	Vcc	V
V_{OL}	Output “L” Voltage	Except XOUT	I_{OL} = 5 mA		–	–	2.0	V
			I_{OL} = 200 μA		–	–	0.45	V
		XOUT	Drive capacity HIGH	I_{OL} = 1 mA	–	–	2.0	V
			Drive capacity LOW	I_{OL} = 500 μA	–	–	2.0	V
V_{T+}-V_{T-}	Hysteresis	$\overline{INT0}$, $\overline{INT1}$, $\overline{INT2}$, $\overline{INT3}$, $\overline{KI0}$, $\overline{KI1}$, $\overline{KI2}$, $\overline{KI3}$, TRAIO, RXD0, RXD1, CLK0, SSI, SCL, SDA, SSO			0.1	0.5	–	V
		$\overline{RESET}$			0.1	1.0	–	V
I_{IH}	Input “H” current		VI = 5 V, Vcc = 5 V		–	–	5.0	μA
I_{IL}	Input “L” current		VI = 0 V, Vcc = 5 V		–	–	-5.0	μA
R_{PULLUP}	Pull-Up Resistance		VI = 0 V, Vcc = 5 V		30	50	167	kΩ
R_{fXIN}	Feedback Resistance	XIN			–	1.0	–	MΩ
V_{RAM}	RAM Hold Voltage		During stop mode		2.0	–	–	V

NOTE:
1. Vcc = 4.2 to 5.5 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), f(XIN) = 20 MHz, unless otherwise specified.

Timing Requirements (Unless Otherwise Specified: Vcc = 5 V, Vss = 0 V at Topr = 25°C) [Vcc = 5 V]

Table 5.16 XIN Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(XIN)}$	XIN input cycle time	50	–	ns
$t_{WH(XIN)}$	XIN input “H” width	25	–	ns
$t_{WL(XIN)}$	XIN input “L” width	25	–	ns

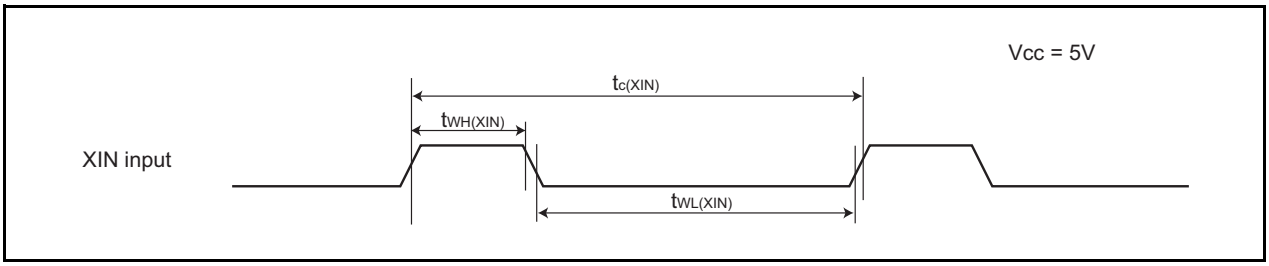

Figure 5.8 XIN Input Timing Diagram when Vcc = 5 V

Table 5.17 TRAIO Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TRAIO)}$	TRAIO input cycle time	100	–	ns
$t_{WH(TRAIO)}$	TRAIO input “H” width	40	–	ns
$t_{WL(TRAIO)}$	TRAIO input “L” width	40	–	ns

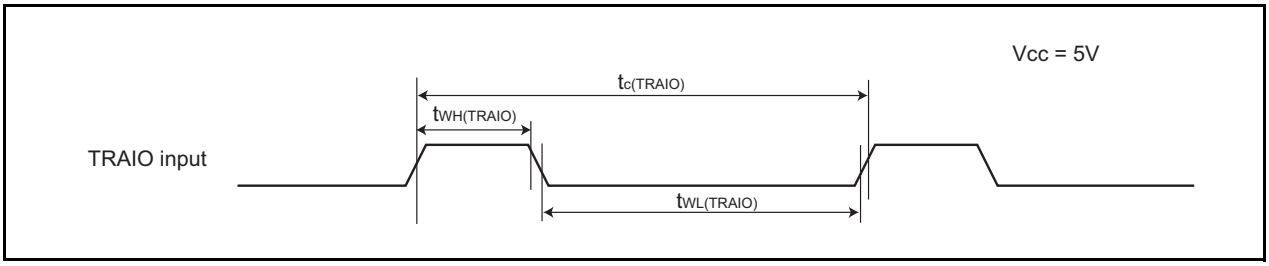

Figure 5.9 TRAIO Input Timing Diagram when Vcc = 5 V

REVISION HISTORY	R8C/22 Group, R8C/23 Group Datasheet

Rev.	Date	Description	
		Page	Summary
0.10	Mar 08, 2005	–	First Edition issued
0.20	Sep 29, 2005	–	Words standardized - Clock synchronous serial interface → Clock synchronous serial I/O - Chip-select clock synchronous interface(SSU) → Clock synchronous serial I/O with chip select - I^2C bus interface(IIC) → I^2C bus interface
		2, 3	Table1.1 R8C/22 Group Performance, Table1.2 R8C/23 Group Performance Serial Interface revised: - Clock Synchronous Serial Interface: 1 channel I^2C bus Interface (3), Clock synchronous serial I/O with chip select - Power-On Reset Circuit added - Power Consumption value determined
		5, 6	Table 1.3 Product Information of R8C/22 Group, Table 1.4 Product Information of R8C/23 Group Date revised.
		7	Figure 1.4 Pin Assignment Pin name revised: - P3_5/$\overline{\text{SSC}}$K(/SCL) → P3_5/ SCL/$\overline{\text{SSC}}$K - P3_4/$\overline{\text{SCS}}$(/SDA) → P3_4/ SDA /$\overline{\text{SCS}}$ - VSS → VSS/AVSS - VCC → VCC/AVCC - P1_5/$\overline{\text{RXD0}}$/(TRAIO/$\overline{\text{INT1}}$) → P1_5/RXD0/(TRAIO)/($\overline{\text{INT1}}$) - P6_6/$\overline{\text{INT2}}$/(TXD1) → P6_6/$\overline{\text{INT2}}$/TXD1 - P6_7/$\overline{\text{INT3}}$/(RXD1) → P6_7/$\overline{\text{INT3}}$/RXD1 - NOTE2 added
		8	Table 1.5 Pin Description - Analog Power Supply Input: line added - I^2C Bus Interface (IIC) → I^2C Bus Interface - SSU → Clock Synchronous Serial I/O with Chip Select
		9	Table 1.6 Pin Name Information by Pin Number revised - Pin Number 1: (SCL) → SCL - Pin Number 2: (SDA) → SDA - Pin Number 9: VSS → VSS/AVSS - Pin Number 11: VCC → VCC/AVCC - Pin Number 26: (TXD1) → TXD1 - Pin Number 27: (RXD1) → RXD1
		15	Table 4.1 SFR Information (1) revised - 0013h: XXXXXX00b → 00h
		17	Table 4.3 SFR Information (3) revised - 00BCh: 0000X000b → 00h/0000X000b
		18	Table 4.4 SFR Information (4) revised - 00D6h: 00000XXXb → 00h - 00F5h: UART1 Function Select Register added
		19	Table 4.5 SFR Information (5) revised - 0104h: TRATR → TRA

REVISION HISTORY	R8C/22 Group, R8C/23 Group Datasheet

Rev.	Date	Description	
		Page	Summary
1.00	Oct 27, 2006	40	Table 5.15 Electrical Characteristics (1) [VCC = 5 V] → Table 5.14 Electrical Characteristics (1) [VCC = 5 V] revised. RAM Hold Voltage, Min.; "1.8" → "2.0" corrected.
		41	Table 5.16 Electrical Characteristics (2) [Vcc = 5 V] → Table 5.15 Electrical Characteristics (2) [Vcc = 5 V] revised. Wait mode revised.
		44	Table 5.21 Electrical Characteristics (3) [VCC = 3 V → Table 5.20 Electrical Characteristics (3) [VCC = 3 V] revised. RAM hold voltage, Min.; "1.8" → "2.0" corrected.
		45	Table 5.22 Electrical Characteristics (4) [Vcc = 3 V] → Table 5.21 Electrical Characteristics (4) [Vcc = 3 V] revised. Wait mode revised.
1.10	Mar 16, 2007	–	D version products added. Relevant descriptions revised because of expanding products - Table 1.1 to 1.4 revised. - Figure 1.2 and 1.3 revised. - Figure 3.1 and 3.2 revised. - Table 5.1 to 5.15 revised. - Table 5.20 and 5.21 revised.
		15	Table 4.1 revised; 000Ah: "00XXX000b" → "00h", 000Fh: "00011111b" → "00X11111b"
		42	Table 5.17 and Figure 5.9 revised; "$\overline{\text{INT1}}$ input" deleted
		43	Table 5.19 and Figure 5.11 revised; "i = 0, 2, 3" → "i = 0 to 3"
		46	Table 5.23 and Figure 5.13 revised; "$\overline{\text{INT1}}$ input" deleted
		47	Table 5.25 and Figure 5.15 revised; "i = 0, 2, 3" → "i = 0 to 3"
2.00	Aug 20, 2008	–	"RENESAS TECHNICAL UPDATE" reflected: TN-16C-A172A/E
		5, 6	Table 1.3, Table 1.4 revised Figure 1.2, Figure 1.3; ROM number "XXX" added
		13, 14	Figure 3.1, Figure 3.2; "Expanding area" deleted
		23	Table 4.9 135Fh Address "XXXX0000b" → "00h"
		28	Table 5.2; NOTE2 revised
		30	Table 5.4; NOTE2 and NOTE4 revised
		31	Table 5.5; NOTE2 and NOTE5 revised
		32	Table 5.6; "td(Vdet1-A)" added, NOTE5 added Table 5.7; "td(Vdet2-A)" and NOTE2 revised, NOTE5 added
		33	Table 5.8; "trth" and NOTE2 revised, Figure 5.3 revised